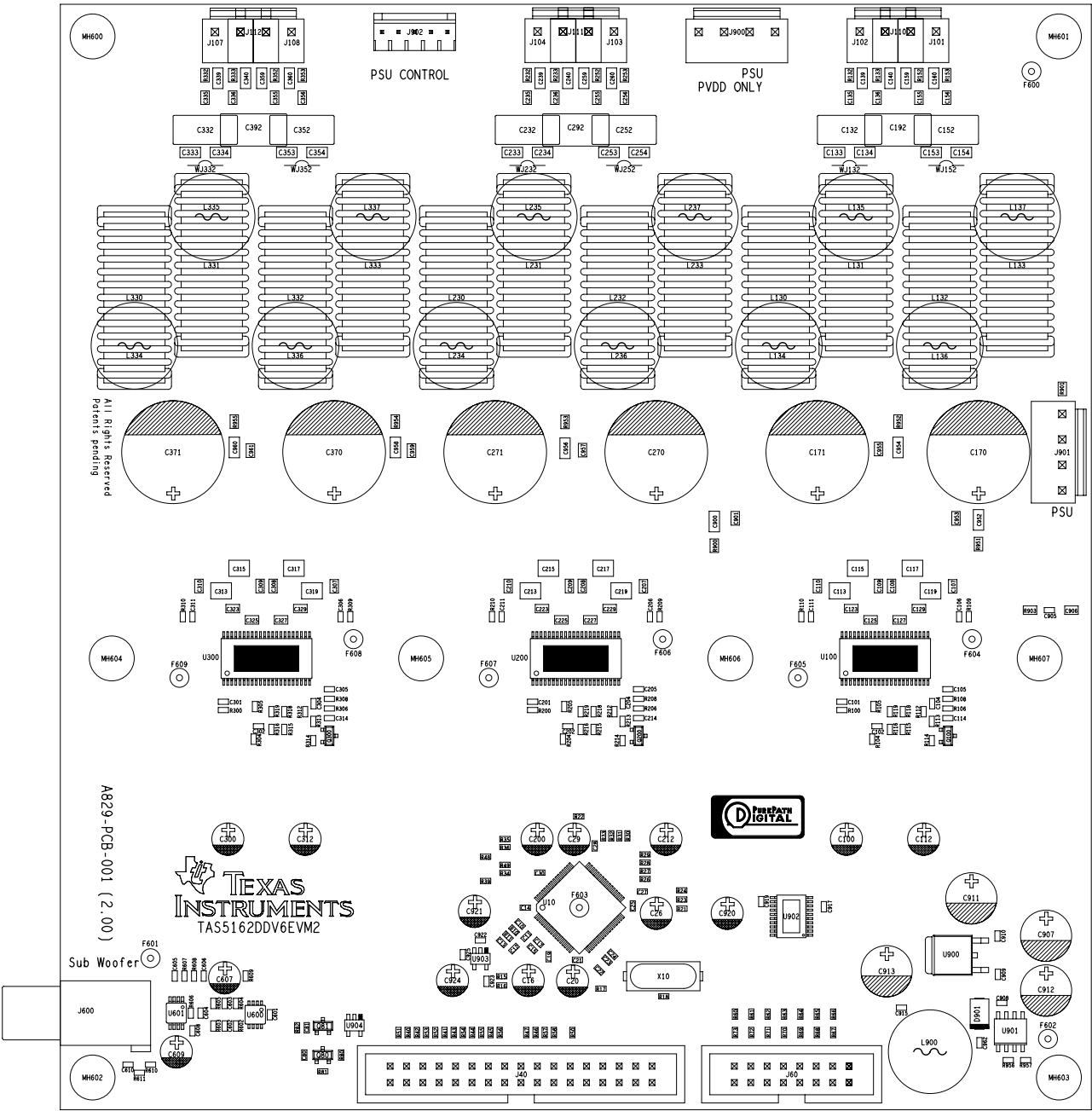


RevNo	Revision note	Date	Signature	Checked
1	INITIAL RELEASE	2007/MAY/03	KR	CMS

- NOTES: UNLESS OTHERWISE SPECIFIED.
- 1. COMPONENT MOUNTING TYPES TOP/BOTTOM : SMD-Leaded / SMD.
 - 2. X,Y COORDINATES AND ROTATION PROVIDED IN DATA FILES.
 - 3. SOLDERING METHODS TYPE TOPSIDE : RES
 - 4. SOLDERING METHODS TYPE BOTSIDE : RES / WAS
 - WAS - Wave soldering
 - RES - Reflow soldering
 - IRS - Infrared soldering
 - MHS - Manual hand-soldering
 - 5. PCB LAYOUT BY GHDSIGN DENMARK. (+45)44441482
 - 6. PCB CONTAINS BGA AND NSMD LEADLESS PACKAGES.



A3	Texas Instruments Lyngby Hovedgade 4, DK-2800 Lyngby		PCB No. A829-PCB-001-2	
			Engineer Jonas Holm	
Designed by KR	Checked by CMS	Approved by Jonas Holm	Date 2007/MAY/03	Scale 100 %
ASSY DRAWING			TAS5162DDV6EVM2	
			A829-PCB-001	Rev 1 Sheet 1 OF 1